



The Future of Analog IC Technology®

# MPQ8633A

16 V, 12 A, Synchronous Step-Down Converter with Adjustable Current Limit, Programmable Frequency, and Voltage Tracking

**MPQ8633AGL IS NOT RECOMMENDED FOR NEW DESIGN**

## DESCRIPTION

The MPQ8633A is a fully integrated, high-frequency, synchronous buck converter. It offers a very compact solution to achieve up to 12 A output current over a wide input supply range with excellent load and line regulation. The MPQ8633A operates at high efficiency over a wide output current load range.

The MPQ8633A adopts internally compensated constant-on-time (COT) control mode that provides fast transient response and eases loop stabilization.

The operating frequency is set easily to 600 kHz, 800 kHz, or 1000 kHz with the MODE configuration, allowing the MPQ8633A frequency to remain constant regardless of the input/output voltages.

The output voltage start-up ramp is controlled by an internal 1 ms timer. It can be increased by adding a capacitor on TRK/REF. An open-drain power good signal indicates the output is within its nominal voltage range. The PGOOD is clamped to around 0.7V with external pull-up voltage when the input supply fails to power the MPQ8633A.

Fully integrated protection features include OCP, OVP, UVP, and OTP.

The MPQ8633A requires a minimum number of readily available, standard, external components and is available in a QFN 3mm x 4mm package.

## FEATURES

- Wide Input Voltage Range from 2.7 V: --2.7 V to 16 V with External 3.3 V Bias, --4 V to 16 V with Internal Bias or External 3.3 V Bias
- Differential Output Voltage Remote Sense
- Programmable Accurate Current Limit Level
- 12 A Output Current
- Low  $R_{DS(ON)}$  Integrated Power MOSFETs
- Proprietary Switching Loss Reduction Technique
- Adaptive COT for Ultrafast Transient Response
- Stable with Zero ESR Output Capacitor
- 0.5% Reference Voltage over 0°C to +70°C Junction Temperature Range
- 1% Reference Voltage from -40°C to +125°C Junction Temperature Range
- Selectable Pulse Skip or Forced CCM Operation
- Excellent Load Regulation
- Output Voltage Tracking
- Output Voltage Discharge
- PGOOD Active Clamped Low Level during Power Failure
- Programmable Soft-Start Time from 1 ms
- Pre-Bias Start-Up
- Selectable Switching Frequency from 600 kHz, 800 kHz, and 1000 kHz
- Non-Latch OCP, UVP, UVLO, Thermal Shutdown, and Latch-Off for OVP.
- Output Adjustable from 0.6 V to 90%\*Vin, up to 5.5 V Max.
- Available in a QFN 3mm x 4mm Package

## APPLICATIONS

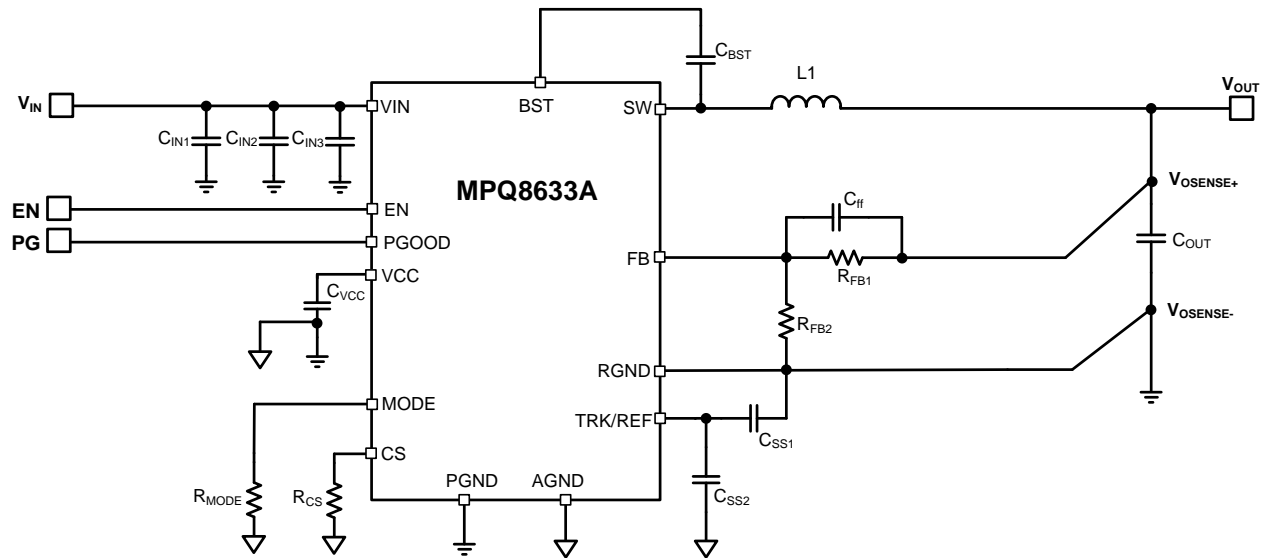
- Telecom and Networking Systems
- Servers
- Base Stations

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## TYPICAL APPLICATION



## ORDERING INFORMATION

Part Number	Package	Top Marking
MPQ8633AGLE*	QFN-21 (3mm x 4mm)	See Below
MPQ8633AGL**	QFN-20 (3mm x 4mm)	See Below

\* For Tape & Reel, add suffix -Z (e.g. MPQ8633AGLE-Z)

\*\* For Tape & Reel, add suffix -Z (e.g. MPQ8633AGL-Z)

\*\*MPQ8633AGL is not recommended for new design

### TOP MARKING (MPQ8633AGLE)

**MPYW**  
**8633**  
**ALLL**  
**E**

### TOP MARKING (MPQ8633AGL)

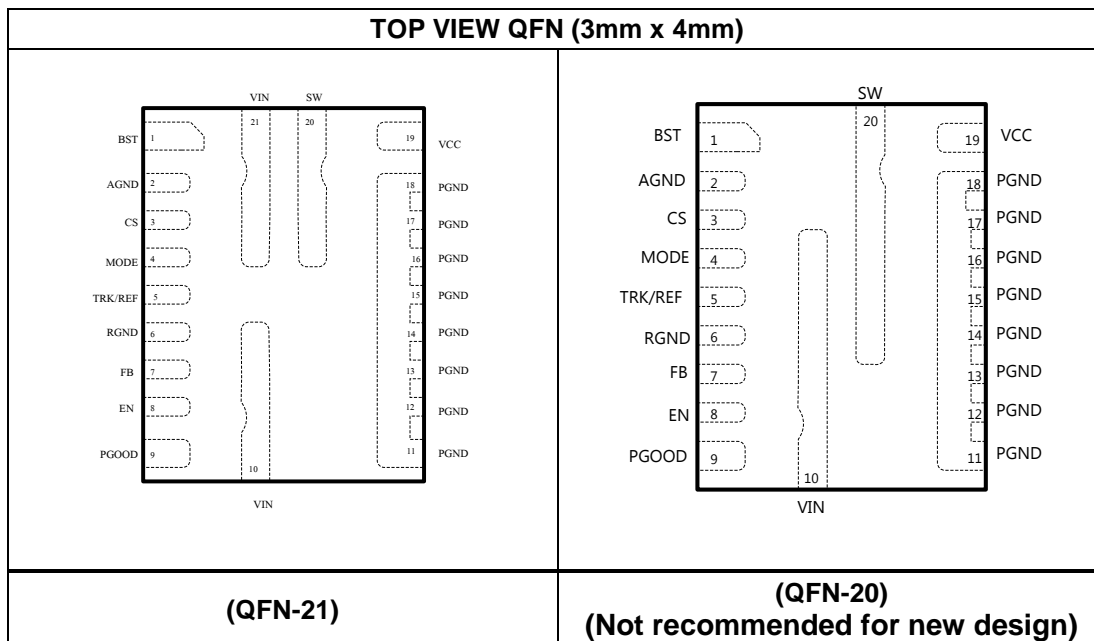
(Not recommended for new design)

**MPYW**  
**8633**  
**ALLL**

MP: MPS prefix  
Y: Year code  
W: Week code  
8633A: First five digits of the part number  
LLL: Lot number  
E: MPQ8633AGLE

MP: MPS prefix  
Y: Year code  
W: Week code  
8633A: First five digits of the part number  
LLL: Lot number

## PACKAGE REFERENCE





**ABSOLUTE MAXIMUM RATINGS** <sup>1)</sup>

Supply voltage ( $V_{IN}$ ) .....	18 V
$V_{SW(DC)}$ .....	-0.3 V to $V_{IN}$
$V_{SW}$ (25 ns) <sup>2)</sup> .....	-3 V to 25 V
$V_{SW}$ (25ns).....	-5V to 25V
$V_{BST}$ .....	$V_{SW} + 4 V$
$V_{CC}, EN$ .....	4.5 V
All other pins .....	-0.3 V to 4.3V
Junction temperature .....	170°C
Lead temperature .....	260°C
Storage temperature.....	-65°C to +170°C

**Recommended Operating Conditions** <sup>3)</sup>

Supply voltage ( $V_{IN}$ ) .....	4 V to 16 V
$V_{IN(DC)} - V_{SW(DC)}$ <sup>4)</sup> .....	-0.3 V to $V_{IN} + 0.3 V$
$V_{SW(DC)}$ <sup>4)</sup> .....	-0.3 V to $V_{IN} + 0.3 V$
Output voltage ( $V_{OUT}$ ).....	0.6 V to 5.5 V
External VCC Bias ( $V_{CC\_EXT}$ ) .....	3.12 V to 3.6 V
Maximum output current ( $I_{OUT\_MAX}$ ) .....	12 A
Maximum output current limit ( $I_{OC\_MAX}$ ) .....	16 A
Maximum peak inductor current ( $I_{L\_PEAK}$ ) .....	18 A
EN Voltage ( $V_{EN}$ ) .....	3.6V
Operating junction temp. ( $T_J$ )... ..	-40°C to +125°C

<b>Thermal Resistance</b> <sup>5)</sup>	$\theta_{JB}$	$\theta_{JC\_TOP}$	
QFN (4mm x 3mm).....	9.....	21.....	°C/W

**NOTES:**

- 1) Exceeding these ratings may damage the device.
- 2) Measured by using differential oscilloscope probe.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) The voltage rating can be in the range of -3V to 23V for a period of 25ns or less with a maximum repetition rate of 1000kHz when the input voltage is 16V.
- 5)  $\theta_{JB}$ : Thermal resistance from junction to board around PGND pin soldering point.  
 $\theta_{JC\_TOP}$ : Thermal resistance from junction to top of package.



## ELECTRICAL CHARACTERISTICS

$V_{IN} = 12\text{ V}$ ,  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ , unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
<b>SUPPLY CURRENT</b>						
Supply current (shutdown)	$I_{IN}$	$V_{EN} = 0\text{ V}$		0	10	$\mu\text{A}$
Supply current (quiescent)	$I_{IN}$	$V_{EN} = 2\text{ V}$ , $V_{FB} = 0.62\text{ V}$		650	850	$\mu\text{A}$
<b>MOSFET</b>						
Switch leakage	$SW_{LKG\_HS}$	$V_{EN} = 0\text{ V}$ , $V_{SW} = 0\text{ V}$		0	10	$\mu\text{A}$
	$SW_{LKG\_LS}$	$V_{EN} = 0\text{ V}$ , $V_{SW} = 12\text{ V}$		0	30	
HS on-state resistance	$R_{DS\_ON\_HS}$	$V_{EN} = 2\text{ V @ } 25^\circ\text{C}$		13.3		$\text{m}\Omega$
LS on-state resistance	$R_{DS\_ON\_LS}$	$V_{EN} = 2\text{ V @ } 25^\circ\text{C}$		3.8		$\text{m}\Omega$
<b>CURRENT LIMIT</b>						
Current limit threshold	$V_{LIM}$		1.15	1.2	1.25	V
$I_{CS}$ to $I_{OUT}$ ratio	$I_{CS}/I_{OUT}$	$I_{OUT} \geq 2\text{ A}$	18	20	22	$\mu\text{A}/\text{A}$
Low-side negative current limit	$I_{LIM\_NEG}$			-9		A
Negative current limit time-out <sup>6)</sup>	$t_{NCL\_Timer}$			200		ns
<b>SWITCHING FREQUENCY</b>						
Switching frequency <sup>7)</sup>	$f_{SW}$	MODE = GND, $I_{OUT} = 0\text{ A}$ , $V_{OUT} = 1\text{ V}$ ,	480	600	720	kHZ
		MODE = 30.1 K, $I_{OUT} = 0\text{ A}$ , $V_{OUT} = 1\text{ V}$ ,	680	800	920	kHZ
		MODE = 60.4 K, $I_{OUT} = 0\text{ A}$ , $V_{OUT} = 1\text{ V}$ ,	850	1000	1150	kHZ
Minimum on time <sup>6)</sup>	$T_{ON\_MIN}$	$V_{FB} = 500\text{ mV}$			50	ns
Minimum off time <sup>6)</sup>	$T_{OFF\_MIN}$	$V_{FB} = 500\text{ mV}$			180	ns
<b>OVER-VOLTAGE AND UNDER-VOLTAGE PROTECTION</b>						
OVP threshold	$V_{OVP}$		113%	116%	119%	$V_{REF}$
UVP threshold	$V_{UVP}$		77%	80%	83%	$V_{REF}$
<b>FEEDBACK VOLTAGE AND SOFT-START</b>						
FEEDBACK voltage	$V_{REF}$	$T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$	594	600	606	mV
		$T_J = 0^\circ\text{C}$ to $+70^\circ\text{C}$	597	600	603	mV
TRK/REF sourcing current	$I_{TRACK\_Source}$	$V_{TRK/REF} = 0\text{ V}$		42		$\mu\text{A}$
TRK/REF sinking current	$I_{TRACK\_Sink}$	$V_{TRK/REF} = 1\text{ V}$		12		$\mu\text{A}$
Soft-start time	$t_{SS}$	$C_{TRACK} = 1\text{ nF}$ , $T_J = 25^\circ\text{C}$	0.75	1	1.25	ms
<b>ERROR AMPLIFIER</b>						
Error amplifier offset	$V_{OS}$		-3	0	3	mV
Feedback current	$I_{FB}$	$V_{FB} = REF$		50	100	nA



## ELECTRICAL CHARACTERISTICS (continued)

$V_{IN} = 12\text{ V}$ ,  $T_J = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ , unless otherwise noted.

ENABLE AND UVLO						
Enable input rising threshold	$V_{IH_{EN}}$		1.17	1.22	1.27	V
Enable hysteresis	$V_{EN_{HYS}}$			200		mV
Enable input current	$I_{EN}$	$V_{EN} = 2\text{ V}$		0		$\mu\text{A}$
Soft shutdown discharge FET	$R_{ON_{DISCH}}$			80	150	$\Omega$
VIN UVLO						
VIN under-voltage lockout threshold rising	$V_{IN_{Vth\_Rise}}$	$V_{CC} = 3.3\text{ V}$	2.1	2.4	2.7	V
VIN under-voltage lockout threshold falling	$V_{IN_{Vth\_Fall}}$		1.55	1.85	2.15	V
VCC REGULATOR						
VCC under-voltage lockout threshold rising	$V_{CC_{Vth\_Rise}}$		2.65	2.8	2.95	V
VCC under-voltage lockout threshold falling	$V_{CC_{Vth\_Fall}}$		2.35	2.5	2.65	V
VCC regulator	$V_{CC}$		2.88	3.00	3.12	V
VCC load regulation		$I_{CC} = 25\text{ mA}$		0.5		%
POWER GOOD						
Power good high threshold	$PG_{Vth\_Hi\_Rise}$	FB from low to high	89.5%	92.5%	95.5%	$V_{REF}$
Power good low threshold	$PG_{Vth\_Lo\_Rise}$	FB from low to high	113%	116%	119%	$V_{REF}$
	$PG_{Vth\_Lo\_Fall}$	FB from high to low	77%	80%	83%	$V_{REF}$
Power good low to high delay	$PG_{Td}$	$T_J = 25^\circ\text{C}$	0.63	0.9	1.17	ms
Power good sink current capability	$V_{PG}$	$I_{PG} = 10\text{ mA}$			0.5	V
Power good leakage current	$I_{PG\_LEAK}$	$V_{PG} = 3.3\text{ V}$			3	$\mu\text{A}$
Power good low-level output voltage	$V_{OL_{100}}$	$V_{IN} = 0\text{ V}$ , Pull PGood up to 3.3 V through a 100 K $\Omega$ resistor @ 25 $^\circ\text{C}$ .		650	800	mV
	$V_{OL_{10}}$	$V_{IN} = 0\text{ V}$ , Pull PGood up to 3.3 V through a 10 K $\Omega$ resistor @ 25 $^\circ\text{C}$ .		750	900	mV
THERMAL PROTECTION						
Thermal shutdown <sup>6)</sup>	$T_{SD}$			160		$^\circ\text{C}$
Thermal shutdown hysteresis <sup>6)</sup>				30		$^\circ\text{C}$

**NOTE:**

6) Guaranteed by design.

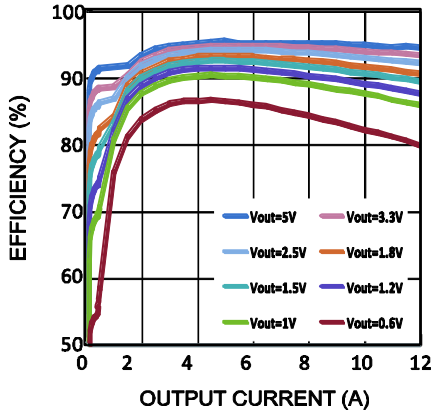
7) Guaranteed by design over temperature..



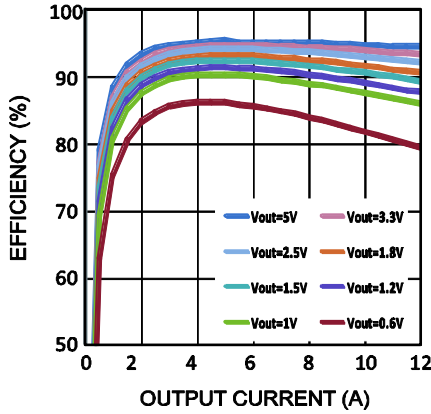
## TYPICAL PERFORMANCE

$V_{IN} = 12\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_{OUT} = 1.2\text{ V}$ ,  $F_S = 800\text{ kHz}$  unless otherwise noted.

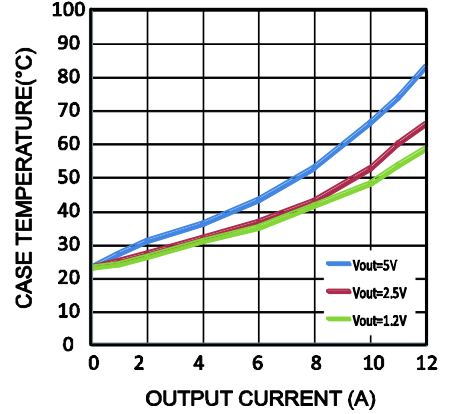
**Efficiency**  
Pulse Skip, 1.1uH, 800kHz



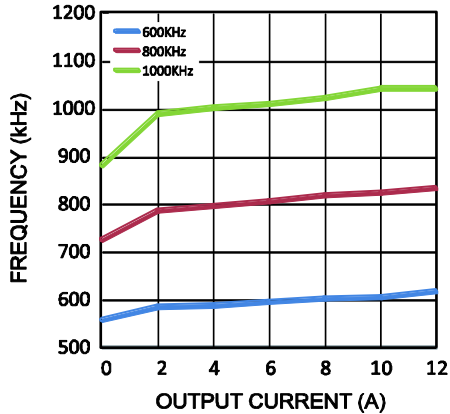
**Efficiency**  
Forced CCM, 1.1uH, 800kHz



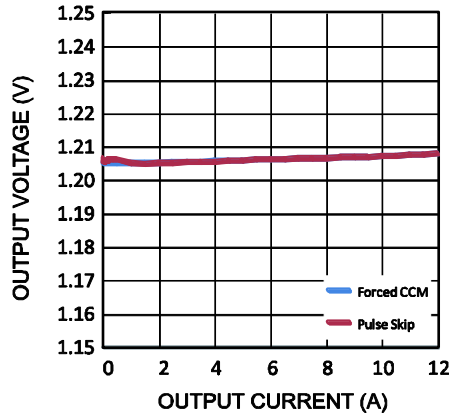
**Thermal Results**  
800kHz



**Switching Frequency vs. Output Current**  
Forced CCM



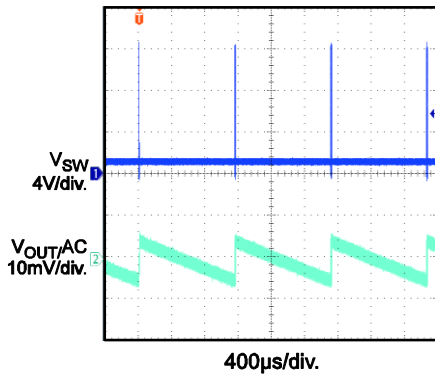
**Output Voltage Load Regulation**



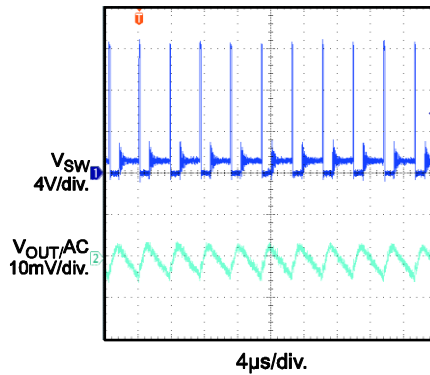
## TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

$V_{IN} = 12\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_{OUT} = 1.2\text{ V}$ ,  $F_S = 800\text{ kHz}$  unless otherwise noted.

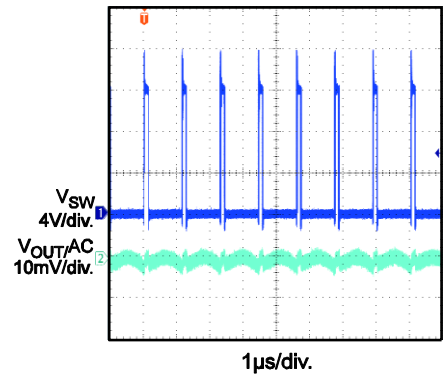
**Steady State**  
 $I_{OUT} = 0\text{ A}$ , Pulse Skip



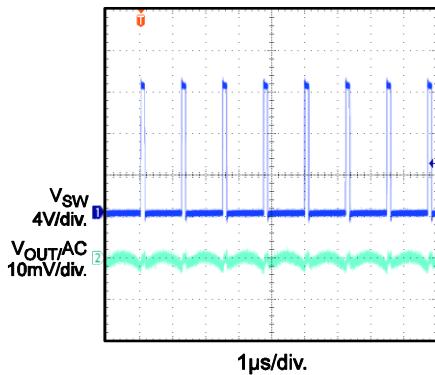
**Steady State**  
 $I_{OUT} = 0.5\text{ A}$ , Pulse Skip



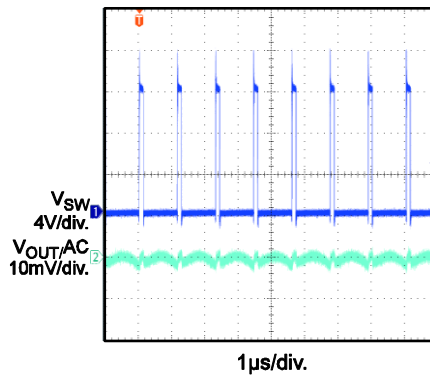
**Steady State**  
 $I_{OUT} = 12\text{ A}$ , Pulse Skip



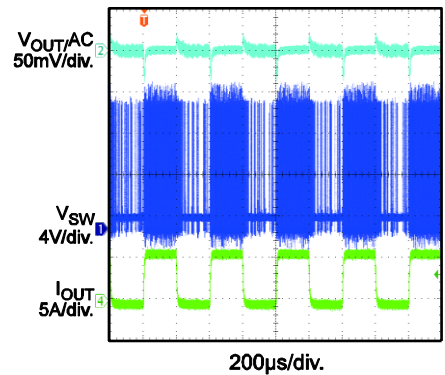
**Steady State**  
 $I_{OUT} = 0\text{ A}$ , Forced CCM



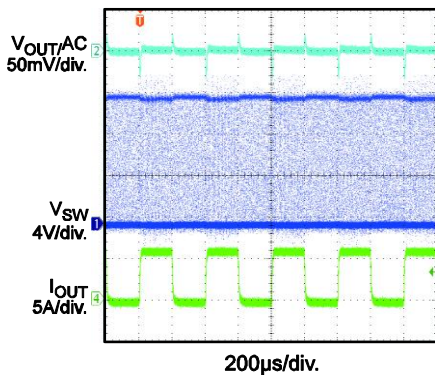
**Steady State**  
 $I_{OUT} = 12\text{ A}$ , Forced CCM



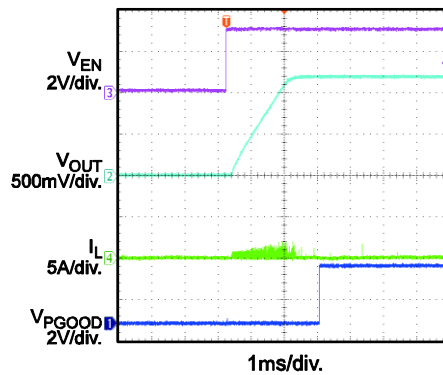
**Load Transient**  
 $I_{OUT} = 0\text{ A}-6\text{ A}$ , Pulse Skip



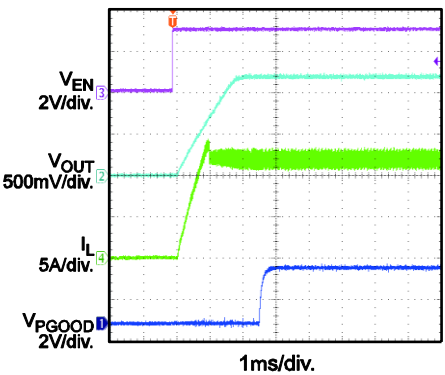
**Load Transient**  
 $I_{OUT} = 0\text{ A}-6\text{ A}$ , Forced CCM



**Power Up through EN**  
 $I_{OUT} = 0\text{ A}$ , Pulse Skip



**Power Up through EN**  
 $I_{OUT} = 12\text{ A}$ , Pulse Skip

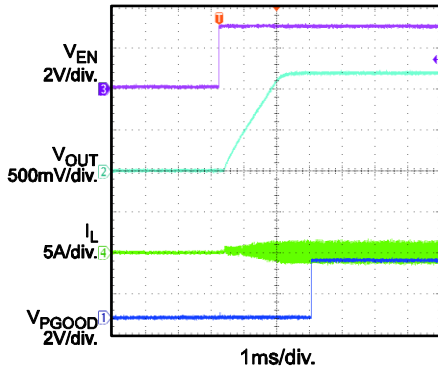




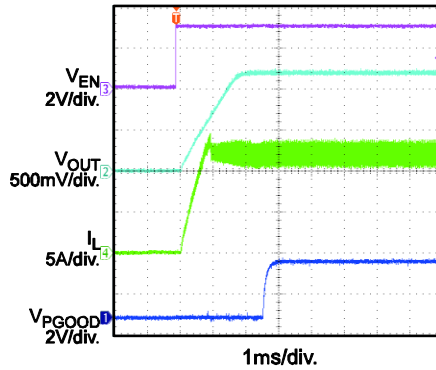
## TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

$V_{IN} = 12\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_{OUT} = 1.2\text{ V}$ ,  $F_S = 800\text{ kHz}$  unless otherwise noted.

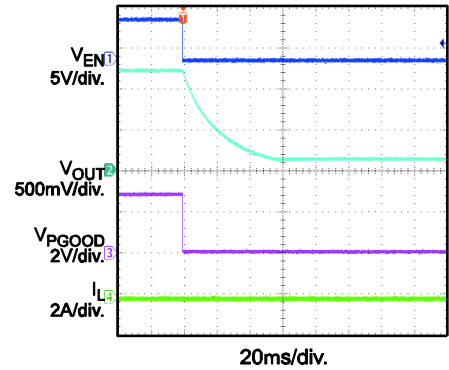
**Power Up through EN**  
 $I_{OUT} = 0\text{ A}$ , Forced CCM



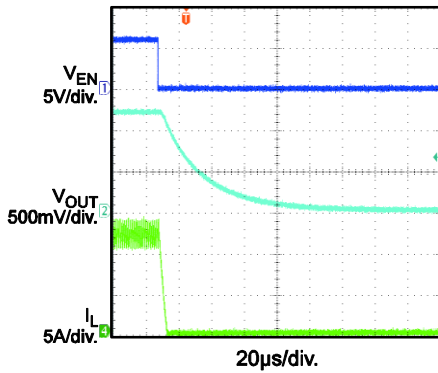
**Power Up through EN**  
 $I_{OUT} = 12\text{ A}$ , Forced CCM



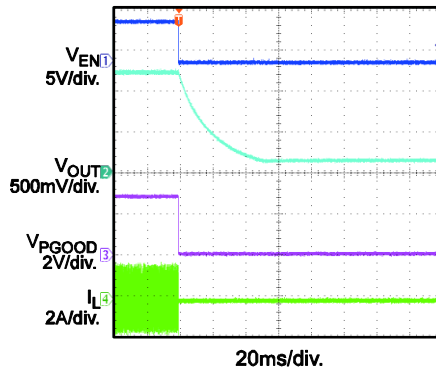
**Power Down through EN**  
 $I_{OUT} = 0\text{ A}$ , Pulse Skip



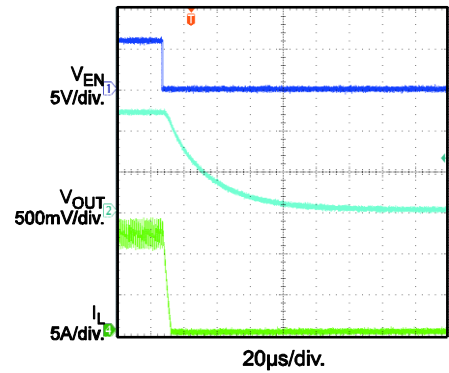
**Power Down through EN**  
 $I_{OUT} = 12\text{ A}$ , Pulse Skip



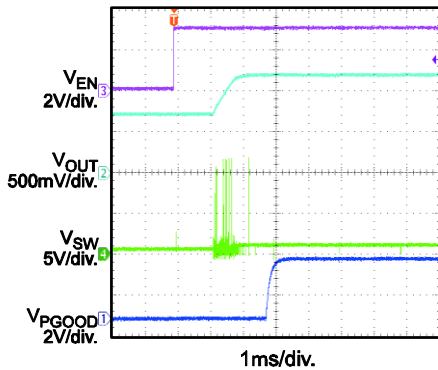
**Power Down through EN**  
 $I_{OUT} = 0\text{ A}$ , Forced CCM



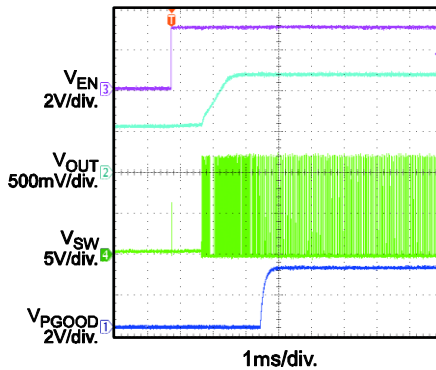
**Power Down through EN**  
 $I_{OUT} = 12\text{ A}$ , Forced CCM



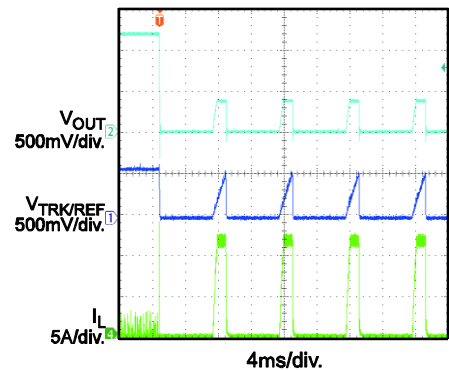
**Pre-bias Start Up**  
Pulse Skip



**Pre-bias Start Up**  
Forced CCM



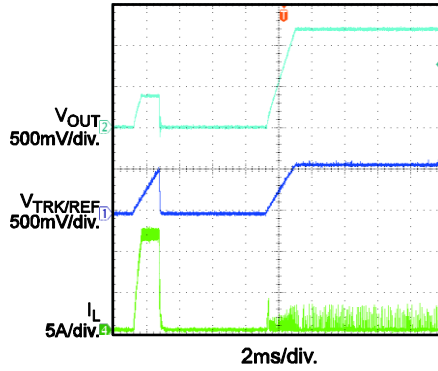
**Over-Current Protection Entry**



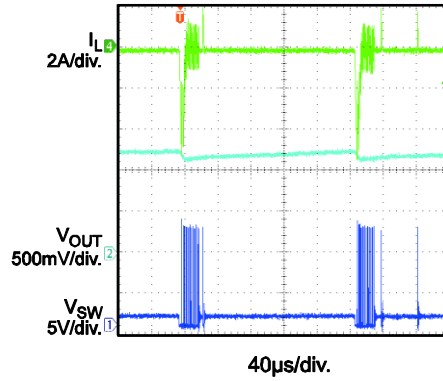
## TYPICAL PERFORMANCE CHARACTERISTICS *(continued)*

$V_{IN} = 12\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_{OUT} = 1.2\text{ V}$ ,  $F_S = 800\text{ kHz}$  unless otherwise noted.

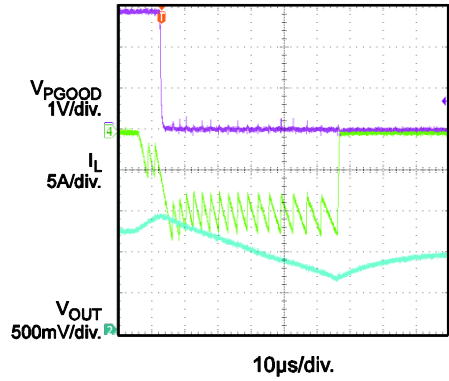
**Over-Current Protection Recovery**



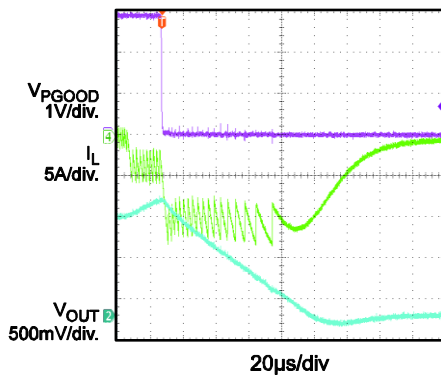
**OSM Operation Pulse Skip Mode**



**Over-voltage Protection Pulse Skip Mode**



**Over-voltage Protection Forced CCM**





## PIN FUNCTIONS

### MPQ8633A (QFN-21)

PIN #	Name	Description
1	BST	<b>Bootstrap.</b> A capacitor connected between SW and BS is required to form a floating supply across the high-side switch driver.
2	AGND	<b>Analog ground.</b> Select AGND as the control circuit reference point.
3	CS	<b>Current limit.</b> Connect a resistor to AGND to set the current limit trip point.
4	MODE	<b>Operation mode selection.</b> Program MODE to select CCM, pulse skip mode, and the operating switching frequency. See table 1 for additional details.
5	TRK/REF	<b>External tracking voltage input.</b> The output voltage tracks this input signal. Decouple with a ceramic capacitor as close to TRK/REF as possible. X7R or X5R grade dielectric ceramic capacitors are recommended for their stable temperature characteristics. The capacitance of this capacitor determines the soft-start time. See Equation 2 for additional details.
6	RGND	<b>Differential remote sense negative input.</b> Connect this pin directly to the negative side of the voltage sense point. Short to GND if remote sense is not used.
7	FB	<b>Feedback (Differential remote sense positive input).</b> An external resistor divider from the output to RGND (tapped to FB) sets the output voltage. It is recommended to place the resistor divider as close to FB as possible. Vias should be avoided on the FB traces.
8	EN	<b>Enable.</b> EN is an input signal that turns the regulator on or off. Drive EN high to turn on the regulator, drive EN low to turn off the regulator. Connect EN to VIN through a pull-up resistor or a resistive voltage divider for automatic start-up. Do NOT float EN.
9	PGOOD	<b>Power good output.</b> This is an open-drain signal. A pull-up resistor (connected to a DC voltage) is required to indicate high if the output voltage is within regulation. There is about 1 ms delay from $FB \geq 92.5\%$ to PGOOD pull-high.
10, 21	VIN	<b>Input voltage.</b> VIN supplies power for the internal MOSFET and regulator. The input capacitors are needed to decouple the input rail. Use wide PCB traces to make the connection.
11-18	PGND	<b>System ground.</b> PGND is the reference ground of the regulated output voltage. For this reason, care must be taken in PCB layout. Use wide PCB traces to make the connection.
19	VCC	<b>Internal 3V LDO output.</b> The driver and control circuits are powered from this voltage. Decouple with a minimum 1 $\mu$ F ceramic capacitor as close to VCC as possible. X7R or X5R grade dielectric ceramic capacitors are recommended for their stable temperature characteristics.
20	SW	<b>Switch output.</b> Connect SW to the inductor and bootstrap capacitor. SW is driven up to the VIN voltage by the high-side switch during the on-time of the PWM duty cycle. The inductor current drives SW low during the off-time. Use wide PCB traces to make the connection.



## MPQ8633A (QFN20)

PIN #	Name	Description
1	BST	<b>Bootstrap.</b> A capacitor connected between SW and BS is required to form a floating supply across the high-side switch driver.
2	AGND	<b>Analog ground.</b> Select AGND as the control circuit reference point.
3	CS	<b>Current limit.</b> Connect a resistor to AGND to set the current limit trip point.
4	MODE	<b>Operation mode selection.</b> Program MODE to select CCM, pulse skip mode, and the operating switching frequency. See table 1 for additional details.
5	TRK/REF	<b>External tracking voltage input.</b> The output voltage tracks this input signal. Decouple with a ceramic capacitor as close to TRK/REF as possible. X7R or X5R grade dielectric ceramic capacitors are recommended for their stable temperature characteristics. The capacitance of this capacitor determines the soft-start time. See Equation 1 for additional details.
6	RGND	<b>Differential remote sense negative input.</b> Connect this pin directly to the negative side of the voltage sense point. Short to GND if remote sense is not used.
7	FB	<b>Feedback (Differential remote sense positive input).</b> An external resistor divider from the output to RGND (tapped to FB) sets the output voltage. It is recommended to place the resistor divider as close to FB as possible. Vias should be avoided on the FB traces.
8	EN	<b>Enable.</b> EN is a input signal that turns the regulator on or off. Drive EN high to turn on the regulator, drive EN low to turn off the regulator. Connect EN to VIN through a pull-up resistor or a resistive voltage divider for automatic start-up. Do NOT float EN.
9	PGOOD	<b>Power good output.</b> This is an open-drain signal. A pull-up resistor (connected to a DC voltage) is required to indicate high if the output voltage is within the regulation. There is about 1 ms delay from $FB \geq 92.5\%$ to PGOOD pull-high.
10	VIN	<b>Input voltage.</b> VIN supplies power for the internal MOSFET and regulator. The input capacitors are needed to decouple the input rail. Use wide PCB traces to make the connection.
11-18	PGND	<b>System ground.</b> PGND is the reference ground of the regulated output voltage. For this reason, care must be taken in PCB layout. Use wide PCB traces to make the connection.
19	VCC	<b>Internal 3V LDO output.</b> The driver and control circuits are powered from this voltage. Decouple with a minimum 1 $\mu$ F ceramic capacitor as close to VCC as possible. X7R or X5R grade dielectric ceramic capacitors are recommended for their stable temperature characteristics.
20	SW	<b>Switch output.</b> Connect SW to the inductor and bootstrap capacitor. SW is driven up to the $V_{IN}$ voltage by the high-side switch during the on-time of the PWM duty cycle. The inductor current drives SW low during the off-time. Use wide PCB traces to make the connection.

## FUNCTIONAL BLOCK DIAGRAM

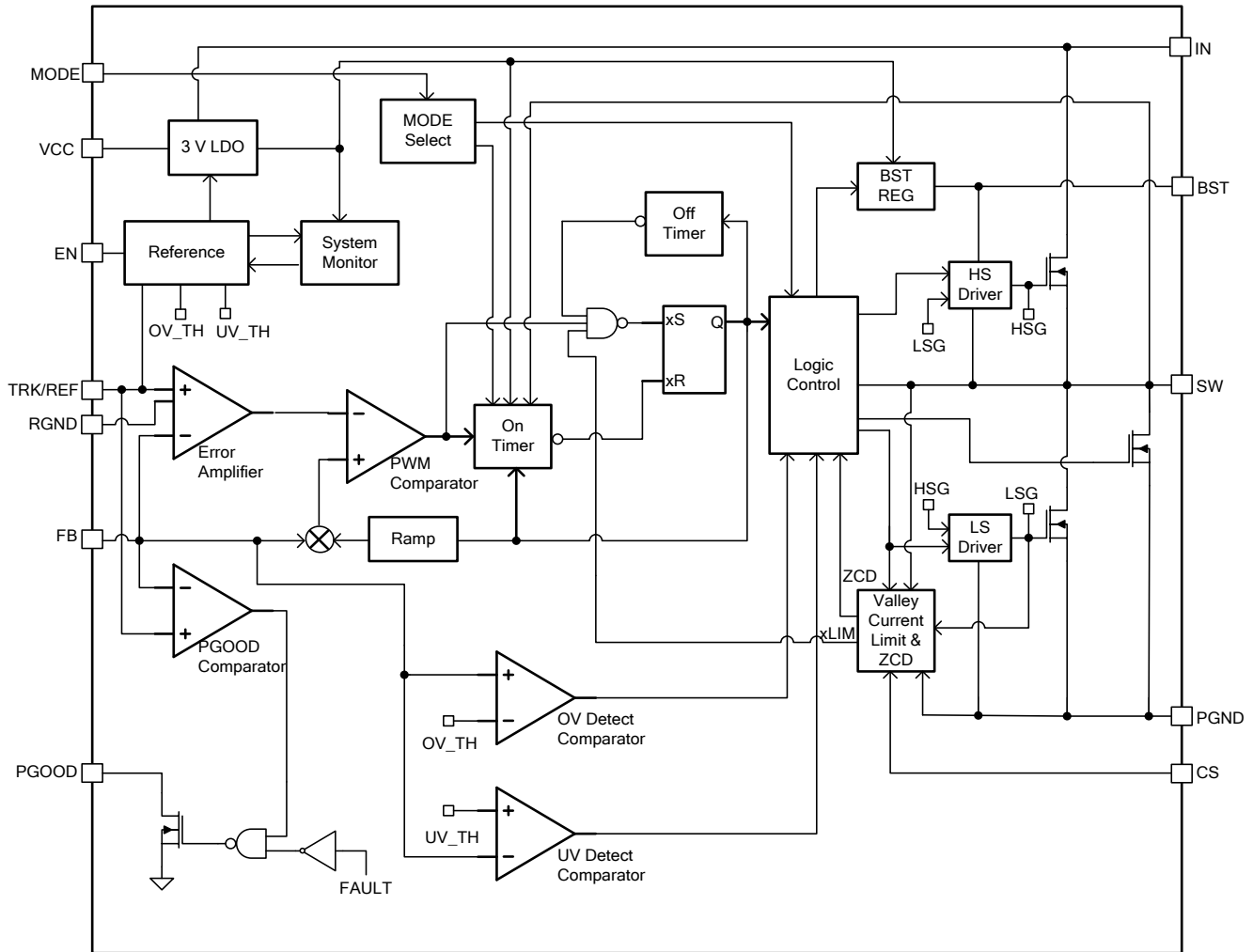


Figure 1—Functional block diagram

## APPLICATION INFORMATION

### COT CONTROL

The MPQ8633A employs constant-on-time (COT) control to achieve fast load transient response. In Figure 2, it shows the details of the control stage of MPQ8633A.

The operational amplifier (AMP) corrects any error voltage between FB and VREF. With the help of AMP, MPQ8633A can provide excellent load regulation over the whole load range, no matter it operates in forced CCM or pulse skip mode.

The dedicated RGND pin helps to provide the feature of the differential output voltage remote sense. The pair of the remote sense trace should be kept in low impedance to achieve the best performance.

The MPQ8633A has internal RAMP compensation, so that it supports low ESR MLCC output capacitor solution. The adaptive internal RAMP is optimized so that the MPQ8633A is stable in the whole operating input/output voltage range with proper design of the output L/C filter.

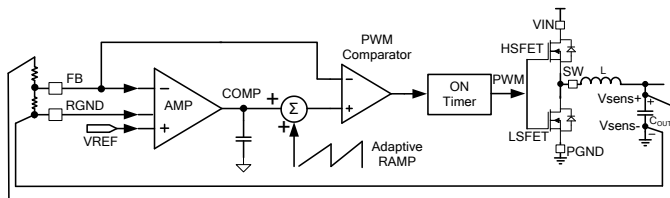


FIGURE 2—COT CONTROL

### PWM OPERATION

In Figure 3, it shows how the PWM is generated. The AMP corrects any error between FB and REF, and generates a fairly smooth DC voltage (COMP). The internal RAMP is superimposed onto COMP. The superimposed COMP is compared with the FB signal. Whenever FB drops below the superimposed COMP, it turns on the integrated high-side MOSFET (HS-FET). The HS-FET keeps on for a fixed turn-on time. The fixed on time is determined by the input voltage, output voltage and selected switching frequency. After the on period elapses, the HS-FET turns off. It turns on again when FB drops below the superimposed COMP. By repeating this operation, the MPQ8633A regulates the output voltage. The integrated low-side MOSFET (LS-FET) turns on when the HS-FET

is in its off state to minimize conduction loss. A dead short occurs between VIN and PGND if both the HS-FET and the LS-FET are turned on at the same time (shoot-through). In order to avoid shoot-through, a dead time (DT) is generated internally between the HS-FET off and the LS-FET on period or the LS-FET off and the HS-FET on period.

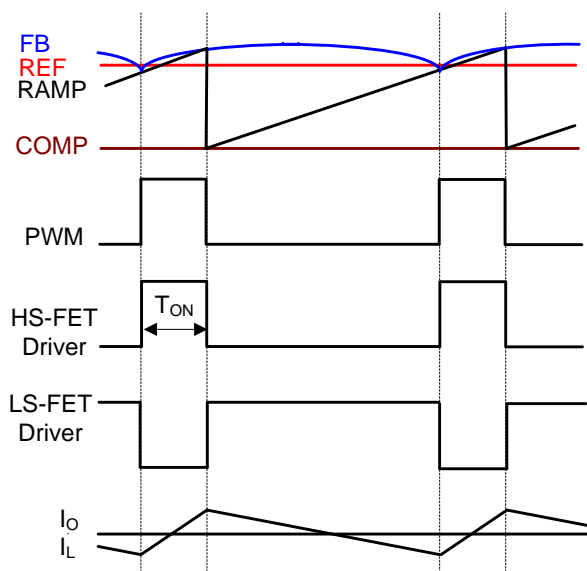


Figure 3—Heavy-load operation (PWM)

### CCM Operation

Continuous conduction mode (CCM) occurs when the output current is high, and the inductor current is always above zero amps (see Figure 2). The MPQ8633A can also be configured to operate in forced CCM operation when the output current is low (See Mode Selection section for details).

In CCM operation, the switching frequency is fairly constant (PWM mode), hence the output ripple keeps almost the same throughout the whole load range.

### Pulse Skip Operation

At light load condition, the MPQ8633A can be configured to work in pulse skip mode to optimize the efficiency. When the load decreases, the inductor current will decrease as



well. Once the inductor current reaches zero, the part transitions from CCM to pulse skip mode if the MPQ8633A is configured so (see Mode Selection section for details).

Figure 4 shows pulse skip mode operation at light-load condition. When FB drops below superimposed COMP, the HS-FET turns on for a fixed interval. When the HS-FET turns off, the LS-FET turns on until the inductor current reaches zero. In pulse skip mode operation, the FB does not reach superimposed COMP when the inductor current approaches zero. The LS-FET driver turns into tri-state (high Z) when the inductor current hits zero. A current modulator takes over the control of the LS-FET and limits the inductor current to less than -1 mA. Hence, the output capacitors discharge slowly to PGND through the LS-FET. At light load condition, the HS-FET is not turned on as frequently in pulse skip mode as it is in forced CCM. As a result, the efficiency in pulse skip mode is improved greatly, comparing with that in forced CCM operation.

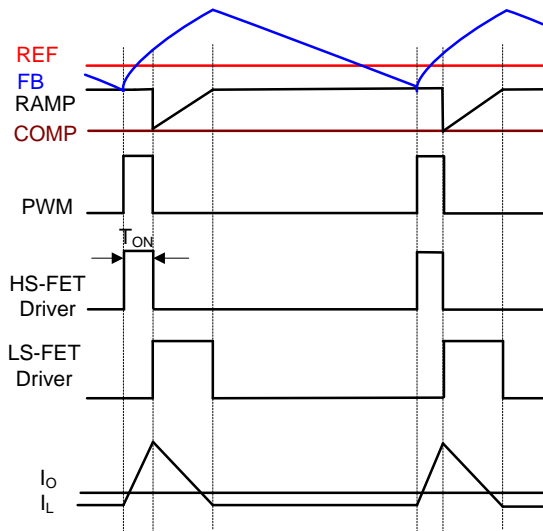


Figure 4—Pulse Skip at Light-load

As the output current increases from the light-load condition, the time period within which the current modulator regulates becomes shorter. The HS-FET is turned on more frequently. Hence, the switching frequency increases accordingly. The output current reaches the critical level when the current modulator time is zero. The critical level of the output current is determined with Equation (1):

$$I_{OUT} = \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{2 \times L \times F_{SW} \times V_{IN}} \quad (1)$$

Where  $F_{SW}$  is the switching frequency.

The part enters PWM mode once the output current exceeds the critical level. After that, the switching frequency stays fairly constant over the output current range.

The MPQ8633A can be configured to operate in forced CCM even in a light-load condition. See Table 1 for MODE configuration.

### Mode Selection

The MPQ8633A provides both forced CCM operation and pulse skip mode operation in a light-load condition. The MPQ8633A has three options for switching frequency selection. Selecting the operation mode under light load condition and the switching frequency is done by choosing the resistance value of the resistor connected between MODE and AGND or VCC (see Table 1).

Table 1—MODE selection

MODE	Light-Load Mode	Switching Frequency
VCC	Pulse skip	600 KHz
243 kΩ (±20%) to GND	Pulse skip	800 KHz
121 kΩ (±20%) to GND	Pulse skip	1000 KHz
GND	Forced CCM	600 KHz
30.1 kΩ (±20%) to GND	Forced CCM	800 KHz
60.4 kΩ (±20%) to GND	Forced CCM	1000 KHz

### Soft Start (SS)

The minimum soft-start time is limited at 1 ms. It can be increased by adding a SS capacitor between TRK/REF and RGND.

The total SS capacitor value can be determined with Equation (2):

$$C_{SS}(\text{nF}) = \frac{t_{ss}(\text{ms}) \times 36\mu\text{A}}{0.6(\text{V})} \quad (2)$$

### Output Voltage Tracking and Reference

The MPQ8633A provides an analog input pin (TRK/REF) to track another power supply or accept external reference. When an external voltage signal is connected to TRK/REF, it acts as a reference for the MPQ8633A output voltage. The FB voltage follows this external voltage signal exactly; the soft-start settings are ignored. The TRK/REF input signal can be in the range of 0.3 V to 1.4 V. During the initial start-up, the TRK/REF needs to reach 600mV or above first to ensure proper operation. After that, it can be any value between 0.3V and 1.4V.

### Pre-Bias Start-Up

The MPQ8633A has been designed for a monotonic start-up into pre-biased loads. If the output is pre-biased to a certain voltage during start-up, the IC disables switching for both the high-side and low-side MOSFETs until the voltage on the TRK/REF capacitor exceeds the sensed output voltage at FB. Before TRK/REF voltage reaches pre-biased FB level, if the BST voltage (from BST to SW) is lower than 2.3V, the LS-FET is turned on to allow the BST voltage to be charged through VCC. The LS-FET is turned on for very narrow pulses, so the drop in pre-biased level is negligible.

### Output Voltage Discharge

When the MPQ8633A is disabled through EN, it enables the output voltage discharge mode. This causes both the HS-FET and the LS-FET to latch off. A discharge FET connected between SW and PGND is turned on to discharge the output voltage. The typical switch on resistance of this FET is about 80 Ω. Once the FB voltage drops below 10%\*REF, the discharge FET is turned off.

### Current Sense and Over-Current Protection (OCP)

The MPQ8633A features an on-die current sense and a programmable positive current limit threshold.

The current limit is active when the MPQ8633A is enabled. During the LS-FET on state, the SW current (inductor current) is sensed and mirrored to CS with the ratio of  $G_{CS}$ . By using a

resistor ( $R_{CS}$ ) from CS to AGND, the  $V_{CS}$  voltage is proportional to the SW current cycle-by-cycle. The HS-FET is only allowed to turn on when the  $V_{CS}$  voltage is below the internal OCP voltage threshold  $V_{OCP}$  (during the LS-FET on state) to limit the SW valley current cycle-by-cycle.

Equation (3) calculates the current limit threshold setting from  $R_{CS}$ :

$$R_{CS} (\Omega) = \frac{V_{OCP}}{G_{CS} \times \left( I_{LIM} - \frac{(V_{IN} - V_O) \times V_O}{V_{IN}} \times \frac{1}{2 \times L \times f_s} \right)} \quad (3)$$

Where,

$V_{OCP} = 1.2 \text{ V}$ ,

$G_{CS} = 20 \mu\text{A/A}$ , and

$I_{LIM}$  = the desired output current limit (A).

The OCP HICCUP is active 3ms after the MPQ8633A is enabled. Once OCP HICCUP is active, if the MPQ8633A detects over-current condition for consecutive 31 cycles, or if the FB drops below under-voltage protection (UVP) threshold, it enters HICCUP mode. In HICCUP mode, the MPQ8633A latches off the HSFET immediately, and latches off LSFET after ZCD is detected. Meanwhile, the TRK/REF capacitor is also discharged. After about 11ms, the MPQ8633A will try to soft start automatically. If the over-current condition still holds after 3ms of running, the MPQ8633A repeats this operation cycle until the over-current condition disappears, and the output voltage rises smoothly back to the regulation level.

### Negative Inductor Current limit

When the LS-FET detects a -9 A current, the part turns off the LS-FET for 200 ns to limit the negative current.

### Output Sinking Mode (OSM)

The MPQ8633A employs output sinking mode (OSM) to regulate the output voltage to the targeted value. When the FB voltage is higher than 104%\*REF but is below the OVP threshold, it triggers OSM. During OSM operation, the LS-FET remains on until it hits the -5.5A negative current limit. Upon hitting -5.5A, the LS-FET is momentarily turned off for 200ns and is then



turned on again. The MPQ8633A keeps this operation until the FB drops below 102%\*REF. Once it does, the MPQ8633A exits OSM after 15 consecutive cycles of forced CCM.

### Over-Voltage Protection (OVP)

The MPQ8633A monitors the output voltage by connecting FB to the tap of the output voltage feedback resistor divider to detect an over-voltage condition. This provides latch-off OVP mode.

If the FB voltage exceeds 116% of the REF voltage, it enters latch-off OVP mode. The HS-FET latches off and PGOOD latches low until power recycle of VCC or EN. Meanwhile, the LS-FET remains on until it hits the low-side negative current limit (NOCP). Once it hits NOCP, the LS-FET is momentarily turned off for 200ns and is then turned on again. The MPQ8633A keeps this operation to try to bring down the output voltage. When the FB voltage drops below 50% of the REF voltage, the LS-FET is turned off for pulse skip mode, and keeps turning on for forced CCM operation. If FB rises back to more than 116% of the REF voltage, the LS-FET turns on again with NOCP until FB drops back below 50% of the REF voltage. It needs power recycle of the EN or VIN to clear the OVP fault.

The OVP function is enabled after TRK/REF reaches 600mV.

### Over-Temperature Protection (OTP)

The MPQ8633A has over-temperature protection (OTP). The IC monitors internally the junction temperature. If the junction temperature exceeds the threshold value (160°C, typically), the converter shuts off and discharge the TRK/REF capacitors. This is a non-latch protection. There is about 30°C hysteresis. Once the junction temperature drops to about 130°C, it initiates a soft start.

The OTP function is effective once the MPQ8633A is enabled.

### Output Voltage Setting and Remote Output Voltage Sensing

First, choose a value for  $R_{FB1}$ . Then  $R_{FB2}$  can be determined with Equation (4):

$$R_{FB2}(k\Omega) = \frac{V_{REF}}{V_O - V_{REF}} \times R_{FB1}(k\Omega) \quad (4)$$

To optimize the load transient response, a feed-forward capacitor ( $C_{FF}$ ) is recommended in parallel with  $R_{FB1}$ .  $R_{FB1}$  and  $C_{FF}$  add an extra zero to the system, which improves loop response.  $R_{FB1}$  and  $C_{FF}$  are selected so that the zero formed by  $R_{FB1}$  and  $C_{FF}$  is located around 20 kHz~60 kHz. See Equation (5):

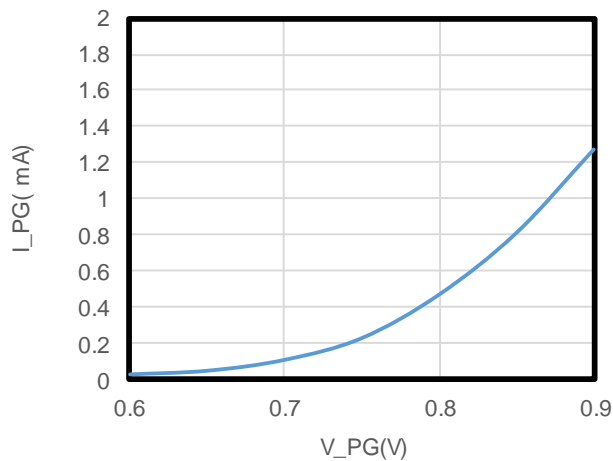
$$f_z = \frac{1}{2\pi \times R_{FB1} \times C_{FF}} \quad (5)$$

### Power Good (PGOOD)

The MPQ8633A has a power good (PGOOD) output. PGOOD is the open-drain of a MOSFET. Connect PGOOD to VCC or another external voltage source (less than 3.6 V) through a pull-up resistor (10 kΩ, typically). After applying the input voltage, the MOSFET turns on, so PGOOD is pulled to GND before TRK/REF is ready. After the FB voltage reaches 92.5 percent of the REF voltage, PGOOD is pulled high after a 0.8 ms delay.

When the FB voltage drops to 80 percent of the REF voltage or exceeds 116 percent of the nominal REF voltage, PGOOD is latched low. PGOOD can only be pulled high again after a new SS.

If the input supply fails to power the MPQ8633A, PGOOD is clamped low even though PGOOD is tied to an external DC source through a pull-up resistor. The relationship between the PGOOD voltage and the pull-up current is shown in Figure 5 below:



**Figure 5: PGOOD clamped voltage v.s. pull-up current**

### EN Configuration

The MPQ8633A turns on when EN goes high, and it turns off when EN goes low. The EN pin can't be left floating for proper operation. It can be driven by an analog or digital control logic signal to enable/disable the MPQ8633A.

The MPQ8633A provides accurate EN thresholds, so a resistor divider from VIN to AGND can be used to program the input voltage at which the MPQ8633A is enabled.

This is highly recommended for the application where there is no dedicated EN control logic signal, to avoid possible UVLO bouncing during power up and power down. The resistor divider values can be determined by equation (6):

$$V_{IN\_START}(V) = V_{IH\_EN} \times \frac{R_{UP} + R_{DOWN}}{R_{DOWN}} \quad (6)$$

$V_{IH\_EN} = 1.22V$  (typical)

$R_{UP}$  and  $R_{DOWN}$  should be chosen that  $V_{EN}$  doesn't exceed 3.6V when  $V_{IN}$  reaches the maximum value.

The EN can also be directly connected to VIN through a pull-up resistor ( $R_{UP}$ ). But the  $R_{UP}$  should be chosen that the maximum current going to EN is 50 $\mu$ A. A easy calculation of the RUP is given in equation (7):

$$R_{UP}(K\Omega) = \frac{V_{INMAX}(V)}{0.05(mA)} \quad (7)$$

## APPLICATION INFORMATION

### Input Capacitor

The input current to the step-down converter is discontinuous, and therefore, requires a capacitor to supply the AC current to the step-down converter while maintaining the DC input voltage. Use ceramic capacitors for best performance. During layout, place the input capacitors as close to VIN pin as possible.

The capacitance can vary significantly with temperature. Use capacitors with X5R and X7R ceramic dielectrics because they are fairly stable over a wide temperature range and they offer very low ESR.

The capacitors must have a ripple current rating that exceeds the converter's maximum input ripple current. Estimate the input ripple current with Equation (8) and Equation (9):

$$I_{CIN} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)} \quad (8)$$

The worst-case condition occurs at  $V_{IN} = 2V_{OUT}$ , where:

$$I_{CIN} = \frac{I_{OUT}}{2} \quad (9)$$

For simplification, choose an input capacitor with an RMS current rating that exceeds half the maximum load current. The input capacitor value determines the converter input voltage ripple. If there is an input voltage ripple requirement in the system, select an input capacitor that meets the specification.

Estimate the input voltage ripple with Equation (10) and Equation (11):

$$\Delta V_{IN} = \frac{I_{OUT}}{F_{SW} \times C_{IN}} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (10)$$

The worst-case condition occurs at  $V_{IN} = 2V_{OUT}$ , where:

$$\Delta V_{IN} = \frac{1}{4} \times \frac{I_{OUT}}{F_{SW} \times C_{IN}} \quad (11)$$

### Output Capacitor

The output capacitor maintains the DC output voltage. Use POSCAP or ceramic capacitors. Estimate the output voltage ripple with Equation (12):

$$\Delta V_{OUT} = \frac{V_{OUT}}{F_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times F_{SW} \times C_{OUT}}\right) \quad (12)$$

When using ceramic capacitors, the capacitance dominates the impedance at the switching frequency. The capacitance also dominates the output voltage ripple. For simplification, estimate the output voltage ripple with Equation (13):

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times F_{SW}^2 \times L \times C_{OUT}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (13)$$

The ESR dominates the switching frequency impedance for the POSCAP capacitors. For simplification, the output ripple can be approximated with Equation (14):

$$\Delta V_{OUT} = \frac{V_{OUT}}{F_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times R_{ESR} \quad (14)$$

### Inductor

The inductor supplies constant current to the output load while being driven by the switching input voltage. A larger value inductor results in less ripple current and lower output ripple voltage but has a larger physical size, a higher series resistance, and/or a lower saturation current. Generally, select an inductor value that allows the inductor peak-to-peak ripple current to be 30 percent to 40 percent of the maximum switch current limit. Also, design for a peak inductor current that is below the maximum switch current limit. Calculate the inductance value using Equation (15):

$$L = \frac{V_{OUT}}{F_{SW} \times \Delta I_L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (15)$$

Where  $\Delta I_L$  is the peak-to-peak inductor ripple current.

Choose an inductor that will not saturate under the maximum inductor peak current. The peak inductor current can be calculated with Equation (16):

$$I_{LP} = I_{OUT} + \frac{V_{OUT}}{2 \times F_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \quad (16)$$

### PCB Layout Guidelines

Efficient PCB layout is critical for stable operation. For optimal performance, refer to Figure 6 and Figure 7 and follow the guidelines below:

1. Place the input MLCC capacitors as close to the VIN and PGND pins as possible. The major MLCC capacitors should be placed on the same layer as the MPQ8633A. Maximize the VIN and PGND copper plane to minimize the parasitic impedance.
2. A 0402 capacitor with a minimum 1  $\mu\text{F}$  value is required. Place the capacitor on the right side of the IC. VIN is extended to the right side to connect the capacitor. At least two 20/10 mil vias should be placed on the ground side of the capacitor to the inner solid ground plain.
3. Place PGND vias (as many as possible and as close to PGND as possible) to minimize both parasitic impedance and thermal resistance.
4. Place the VCC decoupling capacitor close to the device. Connect AGND and PGND at the point of the VCC capacitor's ground connection.
5. Place the BST capacitor as close to BST and SW as possible. Use traces (with a width of 20 mil or wider) to route the path. It is recommended to use a 0.1 $\mu\text{F}$  to 1 $\mu\text{F}$  bootstrap capacitor.
6. Place the REF capacitor close to TRK/REF to RGND. If VIA has to be placed on PGOOD pad, place it at least 10mm away from the positive side of the 1<sup>st</sup> input decoupling capacitor close to the IC.

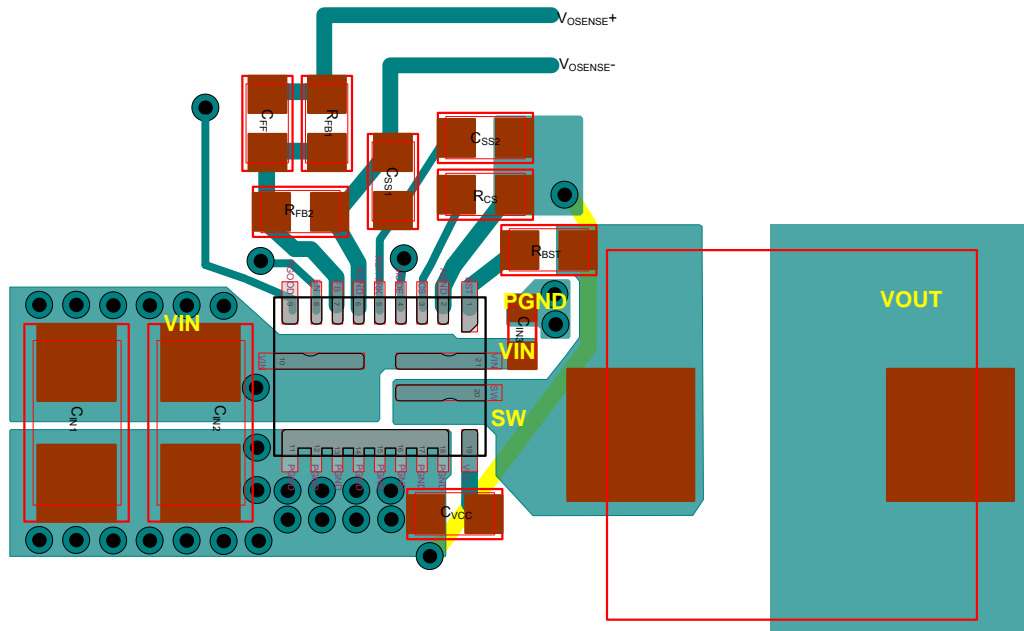


Figure 6—Recommended PCB layout (QFN-21)

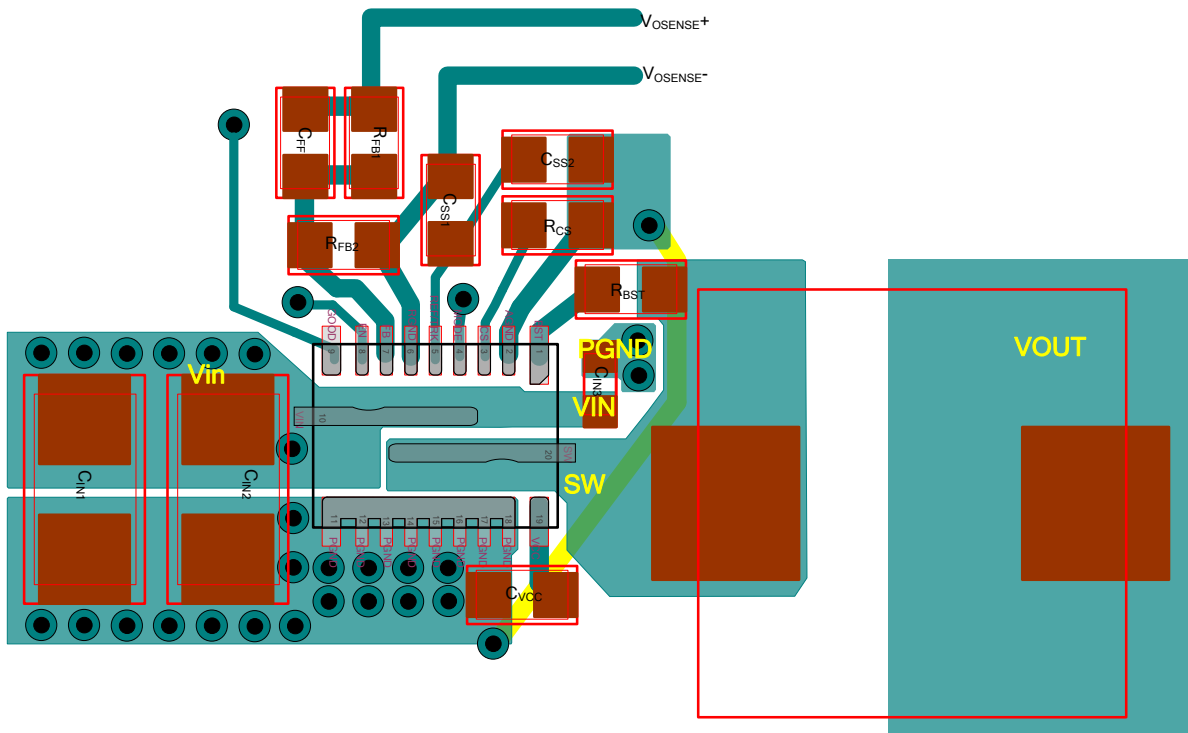
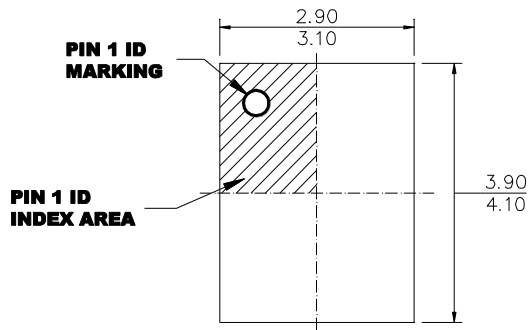


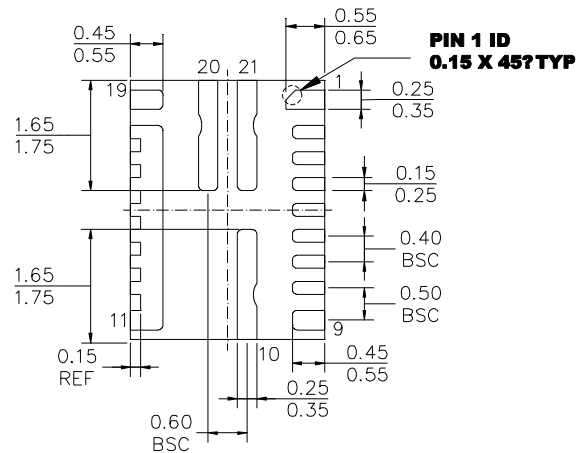
Figure 7—Recommended PCB layout (QFN-20)  
(Not recommended for new design)

## PACKAGE INFORMATION

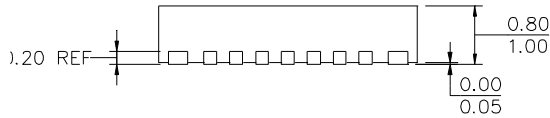
### QFN-21 (3mm x 4mm)



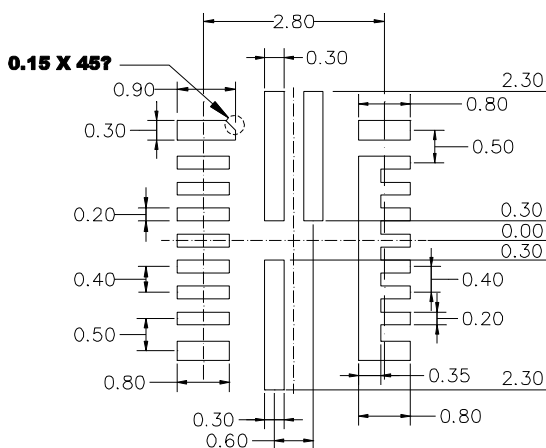
**TOP VIEW**



**BOTTOM VIEW**



**SIDE VIEW**



**RECOMMENDED LAND PATTERN**

### NOTE:

- 1) LAND PATTERN OF PIN1,9,10,11,19,20 AND 21 HAVE THE SAME WIDTH.
- 2) ALL DIMENSIONS ARE IN MILLIMETERS.
- 3) LEAD COPLANARITY SHALL BE 0.08 MILLIMETERS MAX.
- 4) JEDEC REFERENCE IS MO-220.
- 5) DRAWING IS NOT TO SCALE.





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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